

What is claimed is:

1. A liquid crystal display device comprising:

a supporting column provided for an upper substrate
5 and vertically extended from the upper substrate so as
to maintain a uniform cell gap;

a contact part provided for a common line disposed
at a peripheral region outside an active area of a lower
substrate confronting the upper substrate, wherein the
10 contact part faces the supporting column at a
corresponding position so as to guide a communication
between the supporting column and the common line; and

~~an electrically conductive layer formed on surfaces~~
of the supporting column and the upper substrate, wherein
15 a portion of the electrically conductive layer on the
supporting column is joined to the common line within
the contact part so as to establish a signal
interconnection between the lower substrate and the
upper substrate.

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2. The liquid crystal display device of claim 1,
wherein an insulating layer is further provided for the
common line, and the contact part is a contact hole formed
in the insulating layer so as to expose a portion of the

common line.

3. A method for fabricating a liquid crystal display device, comprising:

5 providing a supporting column for an upper substrate, wherein the supporting column is vertically extended from the upper substrate so as to maintain a uniform cell gap;

forming an electrically conductive layer on surfaces
10 of the supporting column and the upper substrate;

providing a contact part for a common line disposed at a peripheral region outside an active area of a lower substrate confronting the upper substrate, wherein the

contact part faces the supporting column at a
15 corresponding position; and

uniting the lower substrate and the upper substrate so that a portion of the electrically conductive layer on the supporting column is joined to the common line within the contact part, thereby establishing a signal
20 interconnection between the lower substrate and the upper substrate.

4. The method of claim 3, wherein the providing of the contact part includes providing an insulating layer

for the common line and forming a contact hole in the insulating layer so as to expose a portion of the common line.

- 5 5. The method of claim 3, wherein the electrically conductive layer includes an indium tin oxide (ITO) layer.

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